

# Broduct data sheet

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MSK7804 Semiconductor Compiance

#### Description

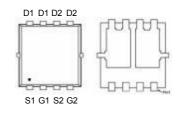
The MSK7804 is the high cell density trenched Nch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The MSK7804 meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

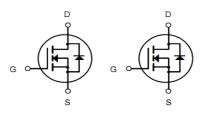
#### **Product Summary**

BVDSS	RDSON	ID
30V	12mΩ	30A

- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- Advanced high cell density Trench technology







**Dual N-Channel MOSFET** 

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	30	V
Vgs	Gate-Source Voltage	±20	V
ID@TA=25°C	Continuous Drain Current, Vgs @ 10V1	30	A
Id@Ta <b>=70</b> °C	Continuous Drain Current, Vos @ 10V1	18	A
Ідм	Pulsed Drain Current <sup>2</sup>	50	A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	24.2	mJ
las	Avalanche Current	22	A
PD@TA=25°C	Total Power Dissipation <sup>4</sup>	1.5	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

#### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
Reja	Thermal Resistance Junction-Ambient <sup>1</sup>		85	°C/W
Rejl	Thermal Resistance Junction-Case <sup>1</sup>		25	°C/W

#### Absolute Maximum Ratings



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### Electrical Characteristics (TJ=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	Vgs=0V , Ib=250uA	30			V
∆BVbss⁄∆Tj	BVDSS Temperature Coefficient	Reference to 25°C , ID=1mA		0.023		V/°C
P	Otatia Davia Ocura Or Daviatara 2	Vgs=10V , Id=8A		10	12	
RDS(ON)	Static Drain-Source On-Resistance <sup>2</sup>	Vgs=4.5V , Ib=6A		15	18	mΩ
VGS(th)	Gate Threshold Voltage		1.2		2.5	V
riangle VGS(th)	V <sub>GS(th)</sub> Temperature Coefficient	──VGs=VDs,ID =250uA		-5.08		mV/°C
lass	Desig Ocument Lockson Ocument	Vds=24V , Vgs=0V , Tj=25°C			1	
IDSS	Drain-Source Leakage Current	Vds=24V , Vgs=0V , TJ=55°C			5	uА
lgss	Gate-Source Leakage Current	Vgs <i>=</i> ±20V , Vds=0V			±100	nA
gfs	Forward Transconductance	Vds=5V , Id=8A		24		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.8		Ω
Qg	Total Gate Charge (4.5V)			9.63		
Qgs	Gate-Source Charge	Vbs=15V , Vgs=4.5V , Ib=8A		3.88		nC
Qgd	Gate-Drain Charge			3.44		
Td(on)	Turn-On Delay Time			4.2		
Tr	Rise Time	Vdd=15V , Vgs=10V , Rg=1.5Ω Id=8A		8.2		
Td(off)	Turn-Off Delay Time			31		ns
Tf	Fall Time			4		
Ciss	Input Capacitance			940		
Coss	Output Capacitance	Vos=15V,Vos=0V,f=1MHz		131		pF
Crss	Reverse Transfer Capacitance			109		

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current <sup>1,5</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			9	А
Vsd	Diode Forward Voltage <sup>2</sup>	Vgs=0V , Is=1A , Tj=25°C			1	V
trr	Reverse Recovery Time	I⊧=8A , di/dt=100A/µs ,		8		nS
Qrr	Reverse Recovery Charge	TJ=25°C		2.9		nC

Note :

1. The data tested by surface mounted on a 1 inch $^2$  FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width  $\leq 300 us$  , duty cycle  $\leq 2\%$ 

3.The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}\text{=}25V, V_{\text{GS}}\text{=}10V, \text{L=}0.1\text{mH}, \text{I}_{\text{AS}}\text{=}22\text{A}$ 

4.The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



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## **Typical Characteristics**

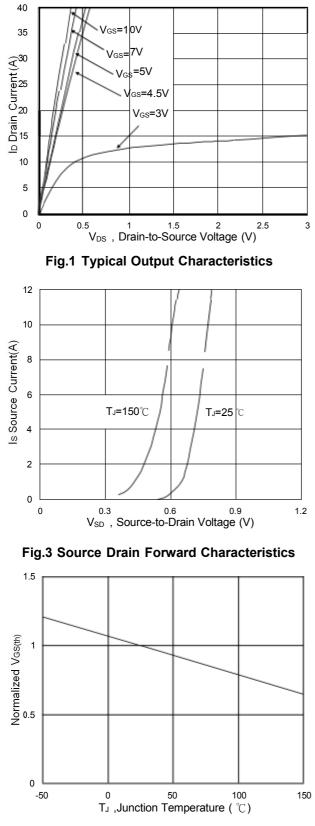


Fig.5 Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>

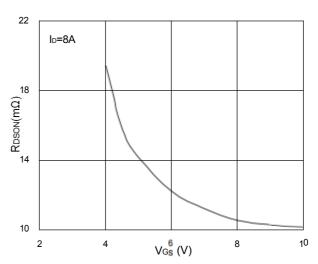


Fig.2 On-Resistance vs. G-S Voltage

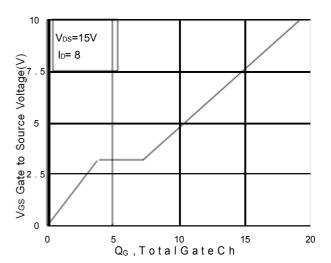


Fig.4 Gate-Charge Characteristics

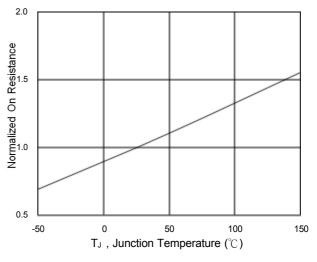
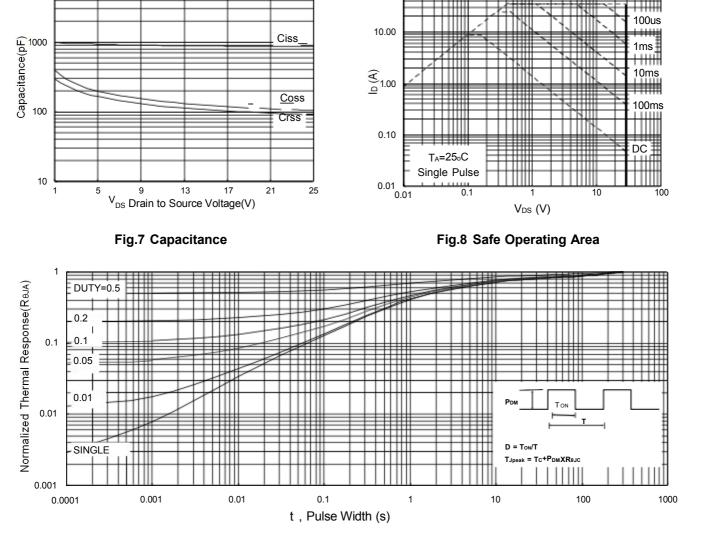


Fig.6 Normalized RDSON vs. TJ



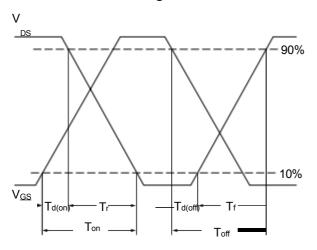
10000

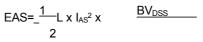


100.00

F=1.0MHz

Fig.9 Normalized Maximum Transient Thermal Impedance





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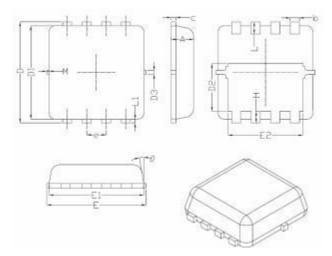
HF

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## DFN3X3-8L Package Information



Querry b al	Dimensions	In Millimeters	
Symbol	Min.	Nom.	Max.
A	0.70	0.75	0.80
b	0.25	0.30	0.35
С	0.10	0.15	0.25
D	3.25	3.35	3.45
D1	3.00	3.10	3.20
D2	1.48	1.58	1.68
D3	_	0.13	-
E	3.20	3.30	3.40
E1	3.00	3.15	3.20
E2	2.39	2.49	2.59
е	0.6	5BSC	
Н	0.30	0.39	0.50
L	0.30	0.40	0.50
L1	-	0.13	-
М	*	*	0.15
θ		10 <sup>°</sup>	12 <sup>°</sup>

## **REEL SPECIFICATION**

Product ID	Pack	Qty(PCS)
MSK7804	DFN3X3-8L	5000



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